#### NPN EPITAXIAL PLANAR TYPE

#### DISCRIPTION

2SC3240 is a silicon NPN epitaxial planar type transistor specifically designed for high power amplifiers in HF band.

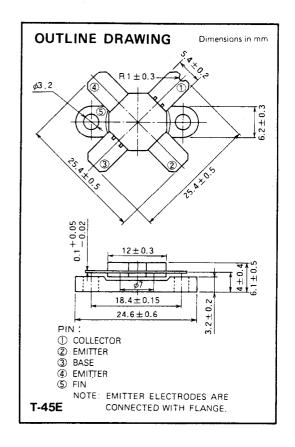
#### **FEATURES**

- High gain:  $G_{pe} \ge 11.5 dB$ ,  $P_0 \ge 100W$ @f = 30MHz,  $V_{CC}$  = 12.5V,  $P_{in}$  = 7W
- High ruggedness: Ability to withstand 20:1 load VSWR when operated at f = 30MHz, P<sub>O</sub> = 100W, V<sub>CC</sub> = 15.2V.
- Emitter ballasted construction
- Low thermal resistance ceramic package with flange. Input-output impedance

$$Z_{in}$$
 = 0.4 - j0.8 ( $\Omega$ )   
  $Z_{out}$  = 1.0 - j1.1 ( $\Omega$ )   
 @f = 30MHz,  $V_{CC}$  = 12.5V,  $P_{o}$  = 100W

#### **APPLICATION**

Output stage of transmitter in HF band SSB mobile radio sets.



#### ABSOLUTE MAXIMUM RATINGS (T<sub>C</sub> = 25°C unless otherwise specified)

Symbol	Parameter	Conditions	Ratings	Unit
V <sub>CBO</sub>	Collector to base voltage		50	, V
V <sub>EBO</sub>	Emitter to base voltage		5	V
V <sub>CEO</sub>	Collector to emitter voltage	R <sub>BE</sub> = ∞	20	V
I <sub>C</sub>	Collector current		25	Α
Pc	Collector dissipation	Ta = 25°C	8	w
		T <sub>C</sub> = 25°C	270	w
Tj	Junction temperature		175	°C
Tstg	Storage temperature		-55 to 175	°C
Rth-a	Thermal resistance	Junction to ambient	18.7	*c/w
Rth-c	Thermal resistance	Junction to case	0.556	°C/W

Note. Above parameters are guaranteed independently.

#### **ELECTRICAL CHARACTERISTICS** (T<sub>C</sub> = 25°C unless otherwise specified)

Symbol	Parameter Test conditions	Limits				
		rest conditions	Min	Тур	Max	Unit
V <sub>(BR)EBO</sub>	Emitter to base breakdown voltage	I <sub>E</sub> =20 mA, I <sub>C</sub> =0	5			V
V(BR)CBO	Collector to base breakdown voltage	I <sub>C</sub> =20mA, I <sub>E</sub> =0	50			V
V <sub>(BR)CEO</sub>	Collector to emitter breakdown voltage	I <sub>C</sub> =100 mA, R <sub>BE</sub> = ∞	20			V
<sup>I</sup> сво	Collector cutoff current	V <sub>CB</sub> =15V, I <sub>E</sub> =0			5	mA
I <sub>EBO</sub>	Emitter cutoff current	V <sub>EB</sub> =3V, I <sub>C</sub> =0			5	mA
hFE	DC forward current gain *	V <sub>CE</sub> =10V, I <sub>C</sub> =1A	10	50	180	_
Po	Output power	f=30 MHz, V <sub>CC</sub> =12.5V, P <sub>in</sub> =7W	100	110		W
$\eta_{C}$	Collector efficiency		55	60		%

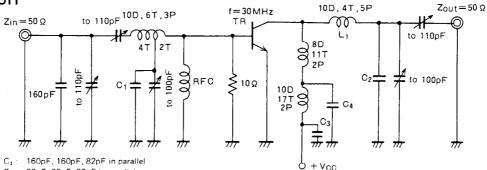
Note. \*Pulse test,  $P_W=150\mu s$ , duty=5%

Above parameters, ratings, limits and conditions are subject to change.



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82pF, 82pF, 82pF in parallel  $C_2$ :

100pF, 4700pF, 4700pF, 0.22µF, 0.22µF, 33µF, 330µF in parallel C<sub>3</sub>:

RFC: 27 Turns 1¢ enameled wire

100pF, 220pF, 4700pF, 0.1μF, 330μF is parallel

All coils but  $L_1$  are made from 1.5 $\phi$ mm silver plated copper wire,  $L_1$  is made from 2.3 $\phi$ mm copper wire.

D: Inner diameter of coil

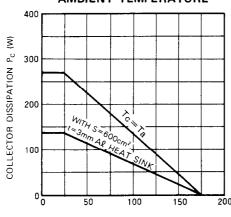
Turn number of coil

P : Pitch of coil

Dimension in milli-meter

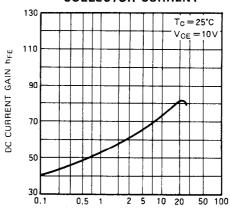
#### TYPICAL PERFORMANCE DATE

#### COLLECTOR DISSIPATION VS. **AMBIENT TEMPERATURE**



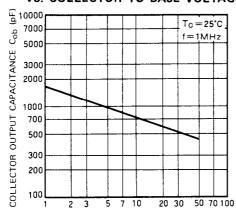
AMBIENT TEMPERATURE Ta (°C)

#### DC CURRENT GAIN VS. COLLECTOR CURRENT



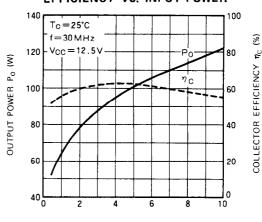
COLLECTOR CURRENT Ic (A)

#### COLLECTOR OUTPUT CAPACITANCE VS. COLLECTOR TO BASE VOLTAGE



COLLECTOR TO BASE VOLTAGE VCB (V)

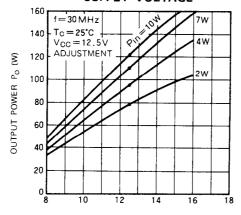
#### **OUTPUT POWER, COLLECTOR EFFICIENCY VS. INPUT POWER**



INPUT POWER Pin (W)

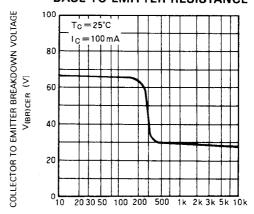
### NPN EPITAXIAL PLANAR TYPE

## OUTPUT POWER VS. COLLECTOR SUPPLY VOLTAGE



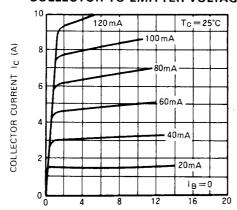
COLLECTOR SUPPLY VOLTAGE  $V_{CC}$  (V)

# COLLECTOR TO EMITTER BREAKDOWN VOLTAGE VS. BASE TO EMITTER RESISTANCE



BASE TO EMITTER RESISTANCE R<sub>BE</sub> (Ω)

## COLLECTOR CURRENT VS. COLLECTOR TO EMITTER VOLTAGE



COLLECTOR TO EMITTER VOLTAGE (V)